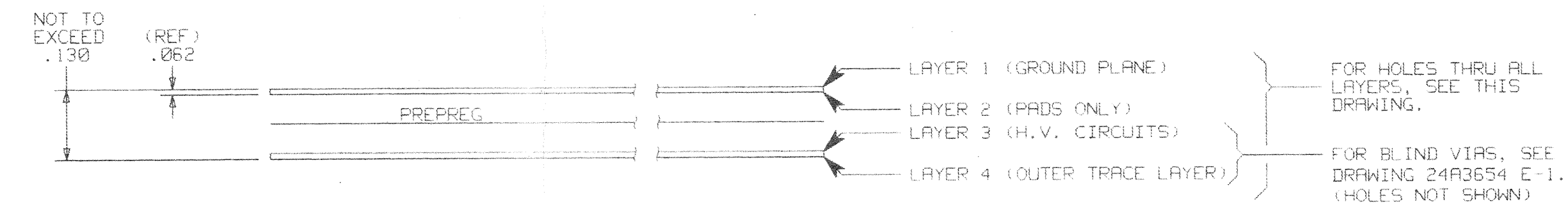


THERE ARE THREE HOLES WITH .125 DIA TO CREATE SLOT. (30 PLACES)

VIEWED FROM LAYER 4

- NOTES:
- BOARD MATERIAL: .062 THICK G10 PER MIL-P-13949G FL-GEN 062C-1/1-A1A (1 OZ COPPER). THIS IS A 4 LAYER BOARD, TOTAL THICKNESS NOT TO EXCEED .130. (1 OZ COPPER MAYBE SUBSTITUTED BY .5 OZ. COPPER)
 - SEE HOLE SCHEDULE FOR HOLE SIZES. HOLES TO BE DRILLED AFTER ASSEMBLY OF ALL LAYERS.
 - THIS BOARD TO BE THROUGH HOLE PLATED.
 - SPECIFIED HOLE DIA. SIZE IS FOR FINISHED HOLES AFTER PLATING.
 - THIS BOARD IS NOT TO BE SILKSCREENED.
 - BOARD SIZE IS 28.100 +/- .005 X 10.300 +/- .010. THIS IS A PANEL OF SIX BOARDS. DIMENSIONS ARE IN INCHES. BOARD OUTLINE DRAWING IS 24A3654 M-2 (a000892m2). SINGLE BOARD SIZE IS 28.100 X 2.781 +/- .005.
 - SOLDERMASK IS NOT USED ON THIS BOARD.
 - REFERENCE DRAWINGS:
 24A3654 E-1 a000892e1 HOLE SCHEDULE - BLIND VIAS
 24A3654 M-1 a000892m1 BOARD OUTLINE - CUTOUTS
 24A3654 M-2 a000892m2 BOARD OUTLINE

HOLE SCHEDULE		
CODE	HOLE DIA.	COUNT
NONE	.026	2088
A	.038	1032
B	.250	100
C	.125	92
TOTAL HOLE COUNT = 3320.		



TITLE		STAR TPC	
I: INNER SECTOR ELECTRONICS			
II: ANODE WIRE MOUNT BOARD - PANEL OF 6			
III: HOLE SCHEDULE - LAYERS 1 THRU 4 (A000892U2)			
ACCOUNT NO.	8052-24	DATE	04-12-94
SERIAL NUMBER		DESIGNED BY	STARKKINEN
DATE ISSUED		APPROVED	
DATE RECD.		ENGINEER	JIM HUNTER
DEL. TO		FILE NO.	a000892e2
		SIZE	4
		DRAWING NO.	24A3654 E-2
		REV.	A
	SCALE NONE	C1,E14,-C14,R19	SHEET 2 of 2